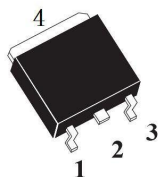


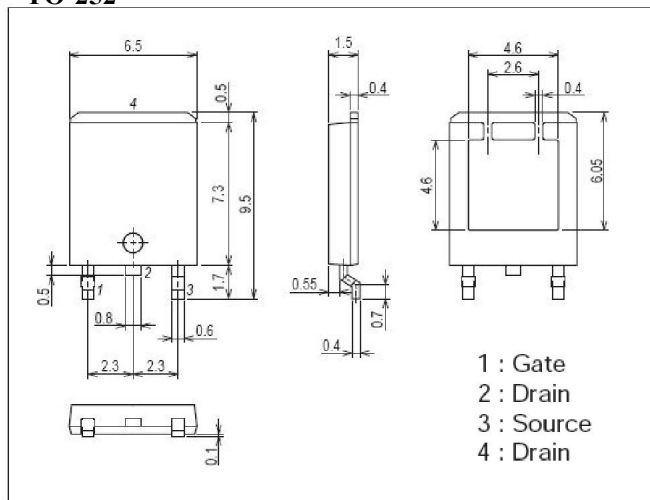
## Features

- Low On resistance.
- 4.5V drive.
- RoHS compliant.



## Package Dimensions

### TO-252



## Specifications

### Absolute Maximum Ratings at $T_a=25^{\circ}\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	$V_{DSS}$		100	V
Gate-to-Source Voltage	$V_{GSS}$		$\pm 20$	V
Drain Current (DC)	$I_D$		18	A
Drain Current (Pulse)	$I_{DP}$	$PW \leq 10\mu\text{s}$ , duty cycle $\leq 1\%$	45	A
Allowable Power Dissipation	$P_D$	Mounted on a ceramic board ( $1000\text{mm}^2 \times 0.8\text{mm}$ ) 1unit	20	W
Total Dissipation	$P_T$	Mounted on a ceramic board ( $1000\text{mm}^2 \times 0.8\text{mm}$ )	25	W
Channel Temperature	$T_{ch}$		150	$^{\circ}\text{C}$
Storage Temperature	$T_{stg}$		$-55 \sim +150$	$^{\circ}\text{C}$

### Electrical Characteristics at $T_a=25^{\circ}\text{C}$

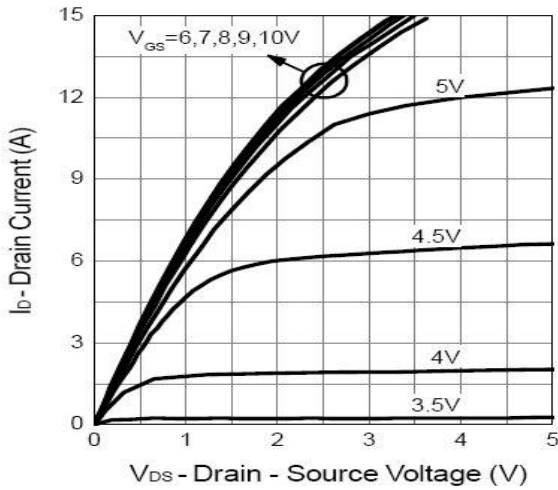
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=250\mu\text{A}$ , $V_{GS}=0\text{V}$	100	-	-	V
Zero-Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=80\text{V}$ , $V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 16\text{V}$ , $V_{DS}=0\text{V}$	-	-	$\pm 10$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$	1	2	3	V
Static Drain-to-Source On-State Resistance	$R_{DS(on)}$	$I_D=10\text{A}$ , $V_{GS}=10\text{V}$	-	78	100	$\text{m}\Omega$
	$R_{DS(on)}$	$I_D=8\text{A}$ , $V_{GS}=4.5\text{V}$	-	90	125	$\text{m}\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=30\text{V}$ , $V_{GS}=0\text{V}$ , $f=1\text{MHz}$	-	660	-	pF
Output Capacitance	$C_{oss}$	$V_{DS}=30\text{V}$ , $V_{GS}=0\text{V}$ , $f=1\text{MHz}$	-	46	-	pF
Reverse Transfer Capacitance	$C_{rss}$	$V_{DS}=30\text{V}$ , $V_{GS}=0\text{V}$ , $f=1\text{MHz}$	-	20	-	pF

Electrical Characteristics at  $T_a=25^{\circ}\text{C}$  (Continued)

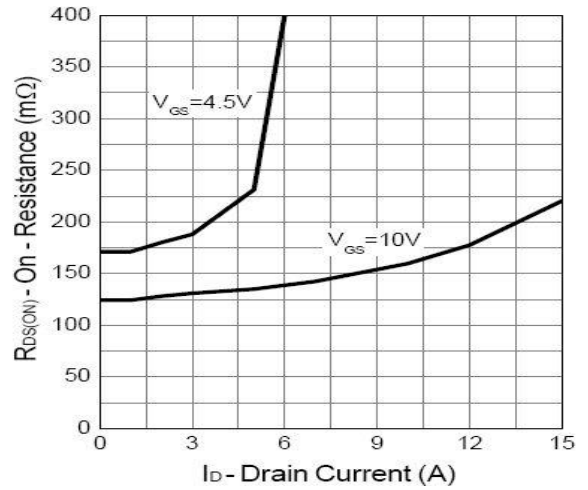
Parameter	Symbol	Conditions	Ratings			Unit
			min	Typ	max	
Turn-on Delay Time	$t_{d(on)}$	$V_{DS}=30\text{V}, R_L=30\Omega, R_{GEN}=6\Omega,$ $V_{GS}=10\text{V}$	-	11	21	nS
Rise Time	$t_r$		-	10	19	nS
Turn-off Delay Time	$t_{d(off)}$		-	21	39	nS
Fall Time	$t_f$		-	13	24	nS
Total Gate Charge	$Q_g$	$V_{DS}=50\text{V}, V_{GS}=10\text{V}, I_D=5\text{A}$	-	9.5	13	nC
Gate-to-Source Charge	$Q_{gs}$		-	1.9	-	nC
Gate-to-Drain "Miller" Charge	$Q_{gd}$		-	2.1	-	nC
Diode Forward Voltage	$V_{SD}$	$I_S=3\text{A}, V_{GS}=0\text{V}$	-	0.8	1.1	V

Typical Characteristics at  $T_a=25^{\circ}\text{C}$

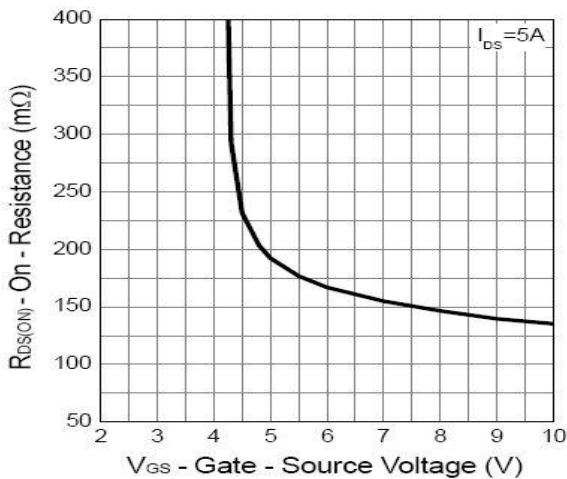
Output Characteristics



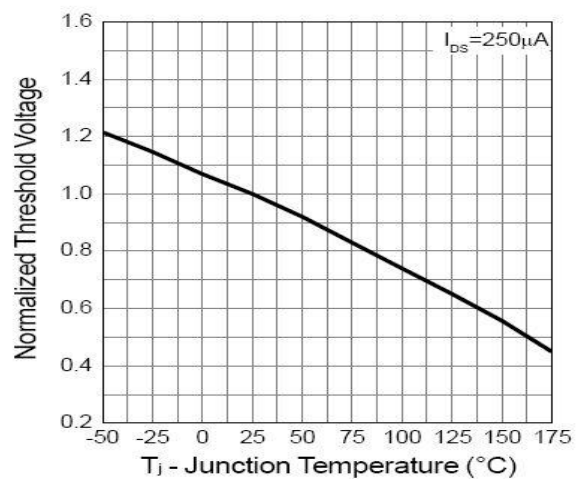
Drain-Source On Resistance



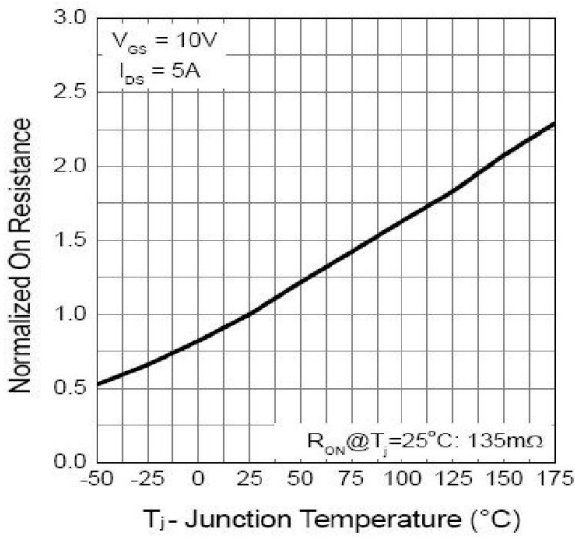
Gate-Source On Resistance



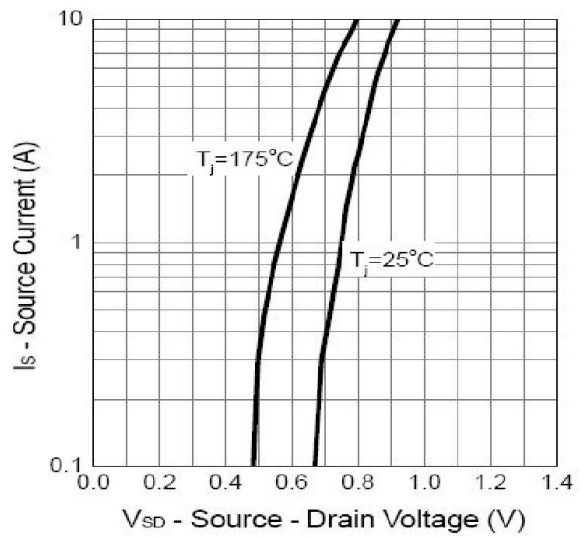
Gate Threshold Voltage



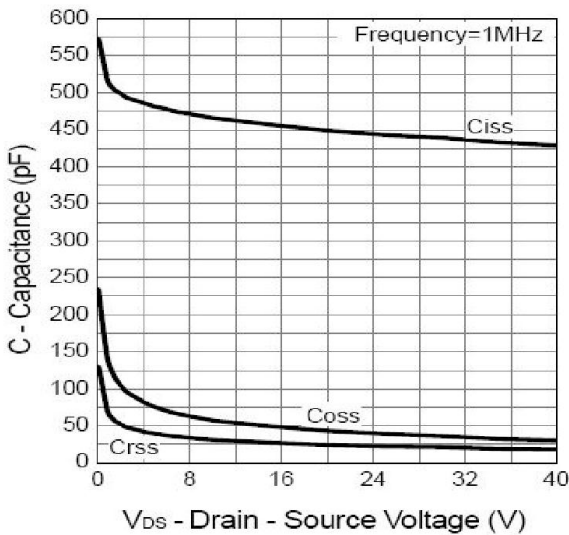
Drain-Source On Resistance



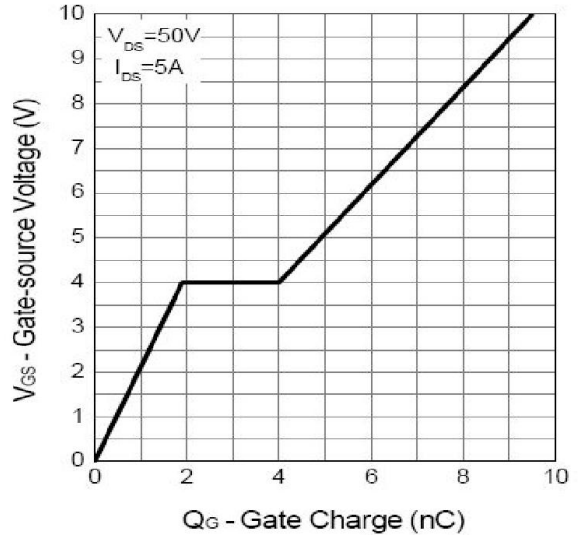
Source-Drain Diode Forward



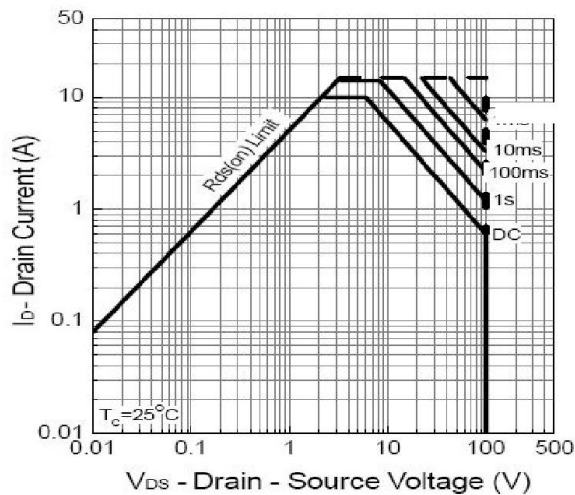
Capacitance



Gate Charge



Safe Operation Area



Thermal Transient In . . . ce

